

(1) Values are given shielded unless marked with (*).
 (2) Converter tube capacitances given are signal grid to plate;
 RF Input Mixer Output.
 x Controlled Heater Warm-up Time, applies only for 600 Ma. condition.
 (3) Has special mechanical and/or life characteristics.
 †† With Average Power Input of 320 Mw. Grid to Grid.
 † For two tubes with 40 volts RMS applied to each grid.
 * Applied through 250,000 ohms.
 # Per Tube or Section.
 ‡ Plate and Target Supply Voltage.
 □ Applied through 20,000 ohms.
 ▲ Conversion Transconductance.
 ** Inode Operation.
 † Pentode Operation.
 ‡ Plate to Plate.
 †† Approximate.
 m maximum
 □ Cathode Resistor
 (ohms).

<p>4 AJ</p>	<p>4 C</p>	<p>4 CB</p>	<p>4 D</p>	<p>4 E</p>	<p>4 K</p>	<p>5 A</p>
<p>5 AA</p>	<p>5 AQ</p>	<p>5 AW</p>	<p>5 BB</p>	<p>5 BC</p>	<p>5 BD</p>	<p>5 K</p>
<p>6 F</p>	<p>6 G</p>	<p>6 Q</p>	<p>6 S</p>	<p>7 Q</p>	<p>8 A 0</p>	<p>8 AV</p>
<p>8 BS</p>	<p>8 V</p>	<p>FM 1000</p>	<p>1222</p>	<p>1236A</p>	<p>1247</p>	

SYMBOLS FOR BASE DIAGRAMS: Dp—Diode Plate, F—Filament, G—Grids numbered according to their position from the cathode, H—Heater, Hc—Heater Center, Ht—Heater Tap, IC—Internal Connection, DO NOT USE,
 J—Jumper, K—Cathode, NC—No Connection, P—Plate, Rc—Ray Control, S—Metal Shell, SA—Starter Anode, T—Target, XS—External Shield, □—Top Cap, ■—Locating Key.